

MHz Range Crystal unit

- Package size (2.0 mm × 1.6 mm × 0.5 mm)
- Fundamental mode
- Reference weight Typ.7.0 mg

[1] Product Number / Product Name / Marking

(1-1) Product Number / Ordering Code

Q22FA12800658xx

Last 2 digits code(xx) defines Quantity.

The standard is "18", 5 000 pcs/Reel.

(1-2) Product Name / Model Name

FA-128 31.948800 MHz 8.0 +30.0-30.0

[2] Absolute maximum ratings

| Parameter | Symbol | Specifications | | | Unit | Conditions |
|-----------------------------|--------|----------------|------|------|------|---------------------------|
| | | Min. | Typ. | Max. | | |
| Storage temperature | T_stg | -40 | - | +125 | °C | Storage as single product |
| Operating temperature range | T_use | -40 | - | +105 | °C | - |

[3] Specifications(characteristics)

| Parameter | Symbol | Specifications | | | Unit | Conditions |
|--------------------------------------|--------|----------------|-----------|------|------------------------|--------------------|
| | | Min. | Typ. | Max. | | |
| Nominal frequency | f_nom | - | 31.948800 | - | MHz | Fundamental |
| Frequency tolerance | f_tol | -30 | - | +30 | x 10 ⁻⁶ | @+25°C |
| Frequency Stability over temperature | f_tem | -30 | - | +30 | x 10 ⁻⁶ | -40°C to +85°C |
| Operating temperature | T_use | -40 | - | +85 | °C | |
| Level of drive | DL | - | 10 | 100 | μW | Recommended: 10 μW |
| Load capacitance | CL | - | 8 | - | pF | |
| Motional resistance (ESR) | R1 | - | - | 60 | Ω | |
| Motional capacitance | C1 | - | TBD | - | fF | |
| Motional inductance | L1 | - | TBD | - | mH | |
| Shunt capacitance | C0 | - | TBD | - | pF | |
| Frequency aging | f_age | -1 | - | +1 | x10 ⁻⁶ /yea | @+25°C, First year |

[For other general specifications, please refer to the attached Full Data Sheet below]

2.0 x 1.6 mm size MHz range crystal unit: FA-128

Features

- Package size: 2.0 x 1.6 mm, t = 0.5 mm Max.
- Frequency range: 19.2 MHz to 54 MHz
- Frequency tolerance (standard): $\pm 10 \times 10^{-6}$ / $\pm 30 \times 10^{-6}$ (@+25 °C)
- Frequency vs. temperature characteristics (standard):
 $\pm 10 \times 10^{-6}$ (-20 °C to +75 °C)
 $\pm 30 \times 10^{-6}$ (-20 °C to +75 °C)
- ESR:
150 Ω Max. (19.2 MHz \leq f_{nom} < 20 MHz)
100 Ω Max. (20 MHz \leq f_{nom} < 24 MHz)
80 Ω Max. (24 MHz \leq f_{nom} < 26 MHz)
60 Ω Max. (26 MHz \leq f_{nom} \leq 54 MHz)



Applications

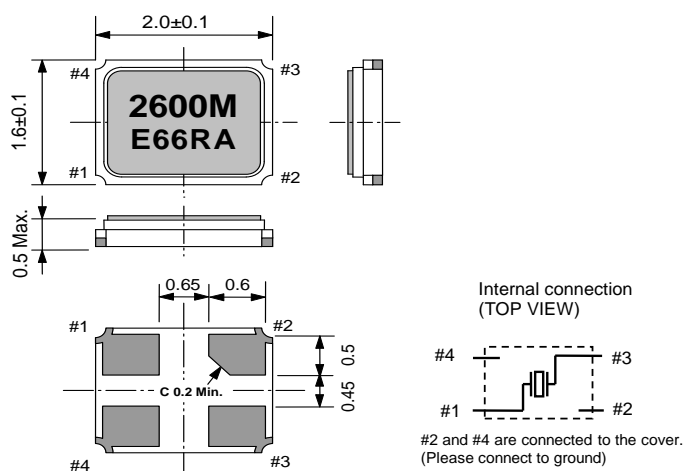
- Small communication module for consumer and industrial applications
- Wearable devices
- Clock for MCU

Description

The FA-128 has been commercialized as a reference clock for communication modules, which requires high accuracy, and as a clock for wireless communication and microcomputers for applications that require miniaturization (TWS (True Wireless Stereo), Smart Watch, etc.).

The products created using the element processing technology cultivated over many years contribute to improving the performance of the customer's system.

Outline Drawing and Terminal Assignment



| Pin | Connection |
|-----|------------|
| #1 | X'tal |
| #2 | GND |
| #3 | X'tal |
| #4 | GND |

[1] Product Number / Product Name

(1-1) Product Number

Q22FA1280xxx18 (Please contact Epson for details)

(1-2) Product Name (Standard Form)

FA-128 24.000000MHz 12.0 +10.0-10.0

① ② ③ ④

①Model ②Frequency ③Load capacitance (pF) ④Frequency tolerance ($\times 10^{-6}$, +25 °C)

In addition to the mentioned above specification items (① to ④),

pleases specify the frequency vs. temperature characteristics.

[2] Absolute Maximum Ratings

| Item | Symbol | Rating value | | | Unit | Note |
|---------------------------|--------|--------------|------|------|------|--|
| | | Min. | Typ. | Max. | | |
| Storage temperature range | T_stg | -40 | - | +125 | °C | Satisfy environmental characteristics specifications |

[3] Operating Conditions

| Item | Symbol | Rating value | | | Unit | Note |
|-----------------------------|--------|--------------|------|------|------|----------------------|
| | | Min. | Typ. | Max. | | |
| Operating temperature range | T_use | -40 | - | +85 | °C | Please contact Epson |
| | | -40 | - | +105 | | |
| Level of drive | DL | 1 | | 200 | μW | Recommended: 10 μW |

[4] Static Characteristics

| Item | Symbol | Specifications | Unit | Condition / Remarks |
|--|--------|--|------------------|--|
| Nominal frequency range | f_nom | 19.2000 to 54.000 | MHz | |
| Frequency tolerance (Standard) | f_tol | ±10 ±30 | $\times 10^{-6}$ | T_use = +25 °C ± 3 °C DL = 100 μW Does not include frequency aging Please contact Epson for requirements not listed in the specifications |
| Frequency vs. temperature characteristics (Standard) | f_tem | ±10 ±30 | $\times 10^{-6}$ | Reference at T_use = +25 °C ± 3 °C -20 °C to +75 °C Please contact Epson for requirements not listed in the specifications |
| Load capacitance | CL | 6 to ∞ | pF | Please specify |
| Motional resistance (ESR) | R1 | Table 1. | Ω | π circuit IEC 60444-2 T_use = Operating temperature range DL = 100 μW |
| Shunt capacitance | C0 | 3.0 Max. | pF | |
| Frequency aging | f_age | ±1 Max. (19.2 MHz ≤ f_nom < 40 MHz) ±2 Max. (40 MHz ≤ f_nom ≤ 54 MHz) | $\times 10^{-6}$ | T_use = +25 °C ± 3 °C First year |

Table 1.

| Frequency | R1 |
|---------------------------|------------|
| 19.2 MHz ≤ f_nom < 20 MHz | 150 Ω Max. |
| 20 MHz ≤ f_nom < 26 MHz | 100 Ω Max. |
| 24 MHz ≤ f_nom < 26 MHz | 80 Ω Max. |
| 26 MHz ≤ f_nom ≤ 54 MHz | 60 Ω Max. |

[5] Example of Frequency Temperature Characteristics

19.2 MHz n = 30



20 MHz n = 30



24 MHz n = 30



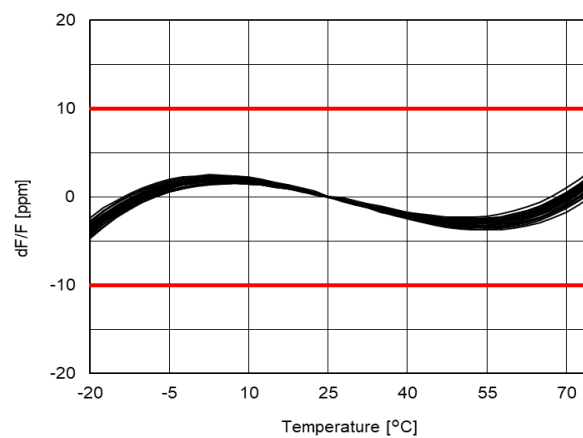
24.576 MHz n = 30



25 MHz n = 30



26 MHz n = 30



27.12 MHz n = 30



32 MHz n = 30



37.4 MHz n = 30



38.4 MHz n = 30



40 MHz n = 30



48 MHz n = 30



52 MHz n = 30



[6] Marking Description



Table 1. Month of manufacture

| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | X | Y | Z |

[7] Outline Drawing and Recommended Footprint



Reference weight Typ.: 7 mg

Terminal coating: Au plating

[8] Moisture Sensitivity Level

| Parameter | Specification | Conditions |
|-----------|---------------|---------------------|
| MSL | LEVEL1 | JEDEC J-STD-020D.01 |

[9] Reflow Profile (JEDEC J-STD-020D.01)

Temperature [°C]



[10] Packing Information

(1) Packing Quantity

The last two digits of the Product Number (Q22FA1280xxxxxx) are a code that defines the packing quantity.
The standard is "18" for a 5 000 pcs / Reel.

(2) Taping Specification

Subject to EAI-481, IEC 60286 and JIS C0806

(2-1) Tape Dimensions

Carrier Tape Material : PS (Polystyrene)

Top Tape Material : PET (Polyethylene Terephthalate) + PE (Polyethylene)



(2-2) Reel Dimensions

Center Material : PS (Polystyrene)

Reel Material : PS (Polystyrene)



[11] Handling Precautions

Prior to using this product, please carefully read the section entitled "Precautions" on our Web site (<https://www5.epsondevice.com/en/information/#precaution>) for instructions on how to handle and use the product properly to ensure optimal performance of the product in your equipment.

Before using the product under any conditions other than those specified therein, please consult with us to verify and confirm that the performance of the product will not be negatively affected by use under such conditions.

In addition to the foregoing precautions, in order to avoid the deteriorating performance of the product, we strongly recommend that you DO NOT use the product under ANY of the following conditions:

1. Max three (3) times re-flow is allowed. Its recommended to manually solder when not enough/no solder detected. (Using soldering iron at +350 °C Max × within 5 seconds)
2. Patterning on a board should follow our company recommended pattern.
3. Too much exciting shock or vibration may cause deterioration on damage.
The product may damage depends on the condition such as a shock in assembly machinery.
Please check your process condition in advance to minimize and maintain the shock level.
4. It is recommended to do patterning to the oscillator as short as possible. Abnormal oscillation may happened if the line is too long.
5. Condensation may occur when products are used/stored under remarkable temperature change.
6. This product may be affected to ultrasonic cleaning. It is depends on the cleaning conditions (Cleaning machine type/power/time/content/position etc.). The warranty will not cover any damage due to this type of usage.
Check conditions prior to use.
7. When the substrate of oscillation become dewy, the crystal frequency is changed or stopped.
Please use under without the dewfall.
8. Applying excessive excitation Drive Level to the crystal Unit may cause deterioration damage.
9. Few data or readings taken at user side may be different from our company's data. Confirmation of the different value is necessary before application.
10. To avoid malfunction, no pattern across or near the crystal is allowed.
11. Start up time of oscillation may be increased or no oscillation may occur unless adequate negative resistance is allocated in the oscillation circuit In order to avoid this, please provide enough negative resistance to the circuit design.

How to check the negative resistance.



- 1) Insert a pure resistance R in series with the X'tal.
- 2) Adjust R and find the maximum R value that starts oscillation.
- 3) Check the value of R in the oscillation state of 2).
Negative resistance of the circuit $|-R| =$
 $R + \text{Series resistance value } R1 \text{ of the X'tal}$
- 4) Negative resistance $|-R|$ guideline:
 $|-R| > R1 \text{ Max. } \times 5$

12. Please refer to packing specification for the storage method and packing standard.

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major manufacturers as standard.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

■ Explanation of marks used in this datasheet

| | |
|---|--|
|  | ● Pb free. |
|  | ● Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive (Contains Pb in sealing glass, high melting temperature type solder or other) |

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